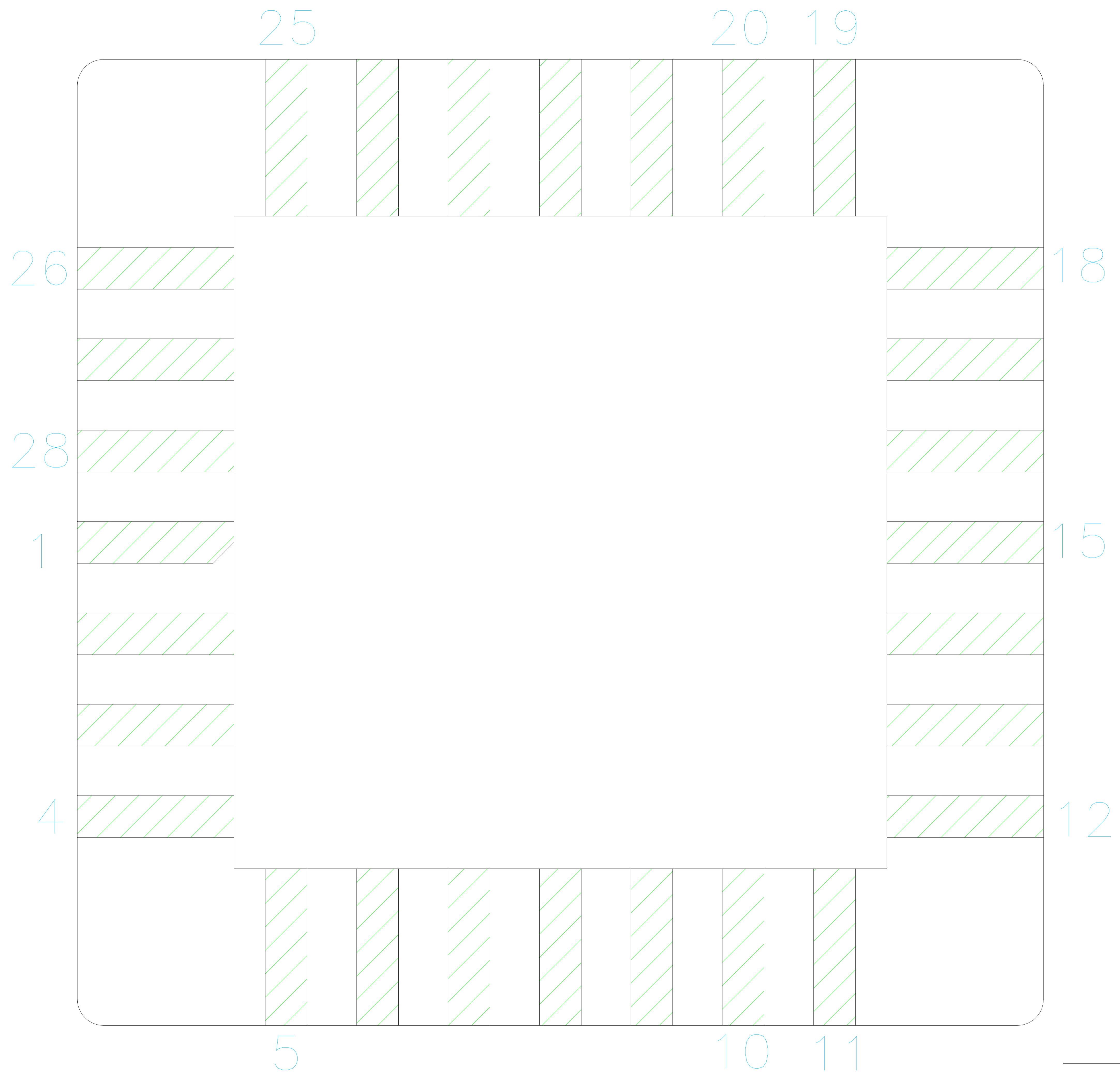
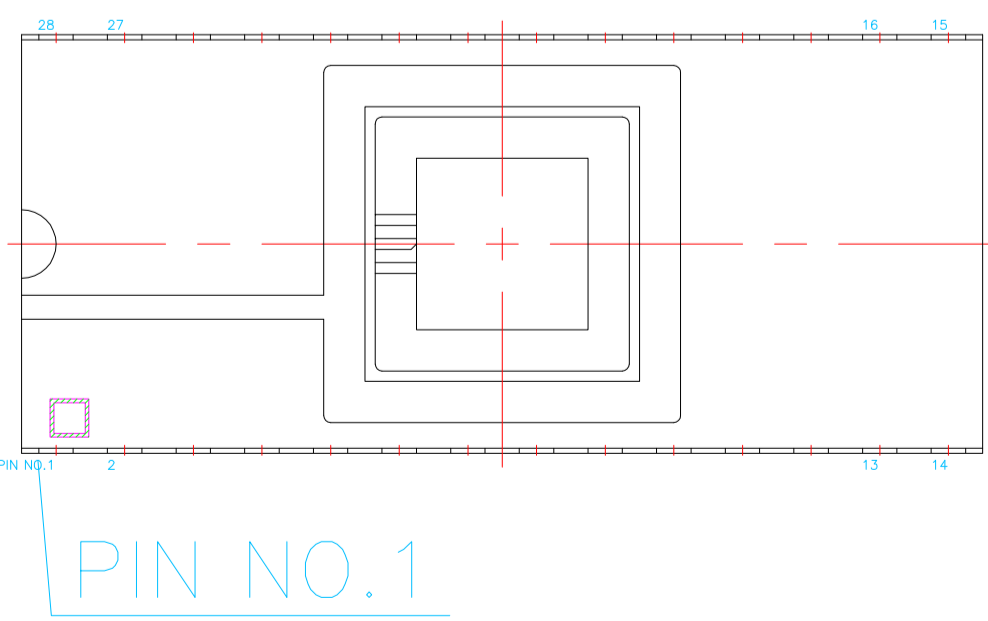


Bonding Diagram

DWG NO. : BCSB-028-62



CHECK BY CUSTOMER



CAD DRAW

Product Name	S/B-28	Die Size	N/A
Pin Count	28	Pad Opening	N/A
Body Type	600 x 1400 mil	Pad Pitch	N/A
Cavity Size	0.250 x 0.250 inch	Wire Count	N/A
DRAW BY :		CHECH BY :	